onsemi

MOSFET – N-Channel, UniFET™, FRFET[®]

500 V, 45 A, 120 m Ω

FDH45N50F

Description

UniFET MOSFET is **onsemi**'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. The body diode's reverse recovery performance of UniFET FRFET MOSFET has been enhanced by lifetime control. Its t_{rr} is less than 100 nsec and the reverse dv/dt immunity is 15 V/ns while normal planar MOSFETs have over 200 nsec and 4.5 V/nsec respectively. Therefore, it can remove additional component and improve system reliability in certain applications in which the performance of MOSFET's body diode is significant. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

Features

- $R_{DS(on)} = 105 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 22.5 \text{ A}$
- Low Gate Charge (Typ. 105 nC)
- Low C_{rss} (Typ. 62 pF)
- 100% Avalanche Tested
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

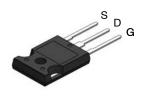
Applications

- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

V _{DS}	R _{DS(ON)} MAX	I _D MAX
500 V	120 m Ω @ 10 V	45 A

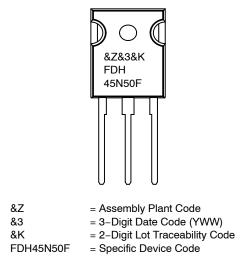
GO

N-CHANNEL MOSFET



TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter		FDH45N50F-F133	Unit V	
V _{DSS}	Drain to Source Voltage		500		
Ι _D	$ \begin{array}{llllllllllllllllllllllllllllllllllll$		45 28.4	A A	
I _{DM}	Drain Current	-Pulsed (Note 1)	180	А	
V _{GSS}	Gate-Source Voltage		±30	V	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		1868	mJ	
I _{AR}	Avalanche Current (Note 1)		45	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)		62.5	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)	Diode Recovery dv/dt (Note 3)		V/ns	
P _D	Power Dissipation	(T _C = 25°C) –Derate Above 25°C	625 5	W W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	Operating and Storage Temperature Range		°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8	300	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive Rating: Pulse width limited by maximum junction temperature. 2. L = 1.46 mH, I_{AS} = 48 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25 °C. 3. $I_{SD} \le 45$ A, di/dt ≤ 200 A/µs, $V_{DD} \le \mathbb{B}V_{DSS}$, Starting T_J = 25 °C.

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Package Method	Reel Size	Tape Width	Quantity
FDH45N50F-F133	FDH45N50F	TO-247-3	Tube	-	-	30 Units

THERMAL CHARACTERISTICS

Symbol	Parameter	FDH45N50F-F133	Unit
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max.	0.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHAR	ACTERISTICS	-				
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	500	-	-	V
$\begin{array}{c} \Delta \text{BV}_{\text{DSS}} \\ / \Delta \text{T}_{\text{J}} \end{array}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C	-	0.5	_	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	25	μΑ
		V_{DS} = 400 V, T_{C} = 125°C	-	-	250	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30$ V, $V_{DS} = 0$ V	-	-	-100	nA
ON CHARA	CTERISTICS			-		
V _{GS(th)}	Gate Threshold Voltage	$V_{DS}=V_{GS},\ I_{D}=250\ \mu A$	3	-	5	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 22.5 A	-	0.105	0.12	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 22.5 \text{ A}$	-	49	-	S
DYNAMIC C	CHARACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz	-	5100	6630	pF
C _{oss}	Output Capacitance		-	790	1030	pF
C _{rss}	Reverse Transfer Capacitance	1	-	62	-	pF
C _{oss}	Output Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	-	161	-	pF
C _{oss} eff.	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	342	-	pF
SWITCHING	CHARACTERISTICS	•	-	-	-	-
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 250 \text{ V}, \text{ I}_{D} = 48 \text{ A},$	-	140	290	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 25 \Omega$ (Note 4)	-	500	1010	ns
t _{d(off)}	Turn-Off Delay Time		_	215	440	ns

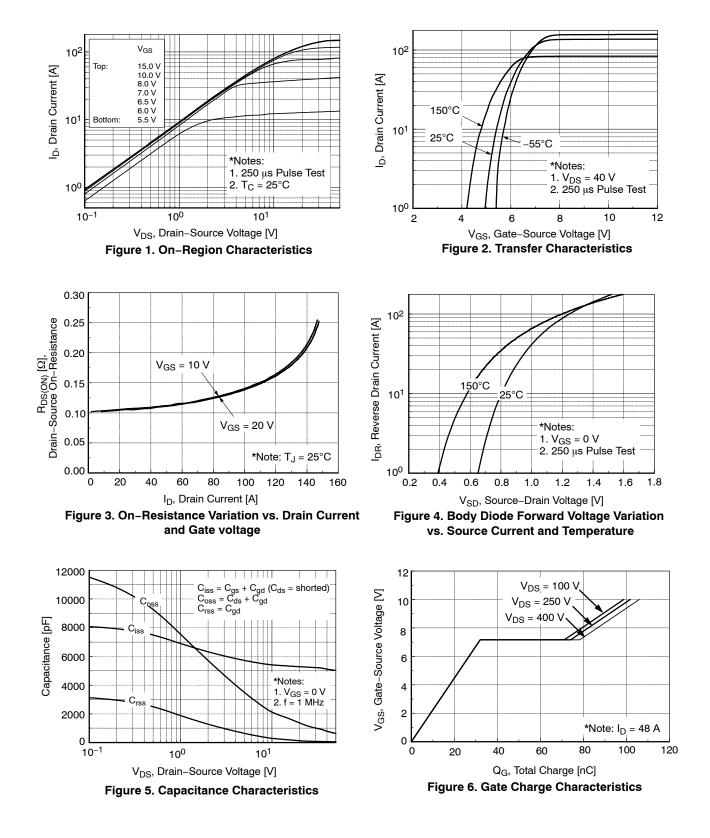
t _{d(off)}	Turn-Off Delay Time		-	215	440	ns
t _f	Turn-Off Fall Time		-	245	500	ns
Qg	Total Gate Charge	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 48 \text{ A},$	-	105	137	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V (Note 4)	-	33	-	nC
Q _{gd}	Gate-Drain Charge		-	45	1	nC

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

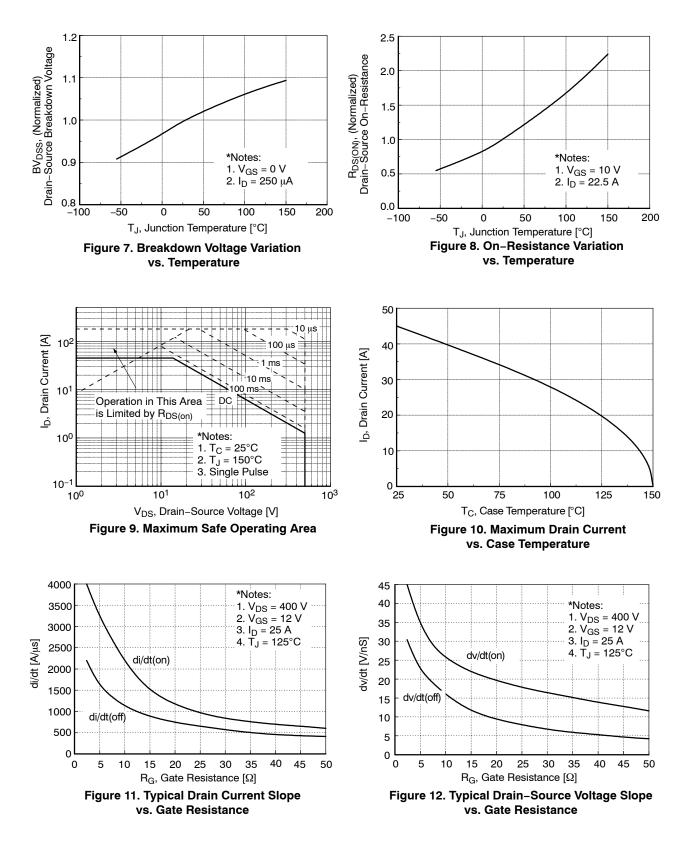
۱ _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	45	А
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		-	-	180	Α
V _{SD}	Source to Drain Diode Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 45 \text{ A}$	-	-	1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 45 A,$	-	188	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/µs	-	0.64	-	μC

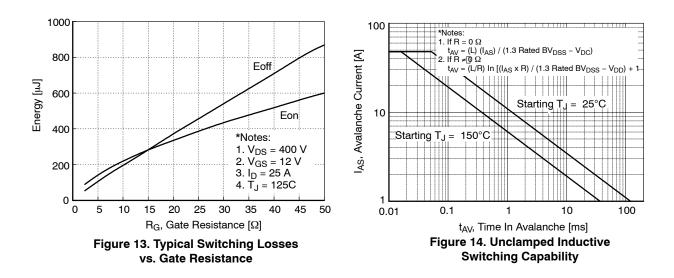
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially Independent of Operating Temperature Typical Characteristics.

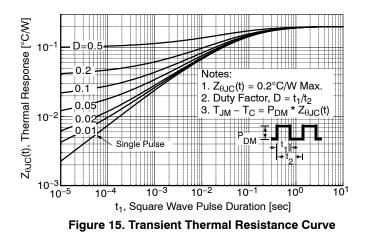
TYPICAL CHARACTERISTICS

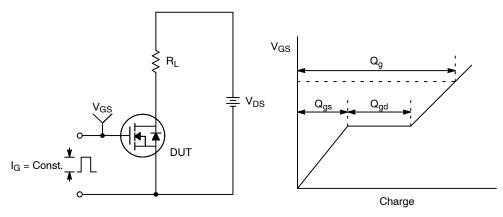


TYPICAL CHARACTERISTICS











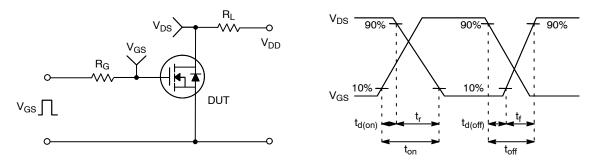


Figure 17. Resistive Switching Test Circuit & Waveforms

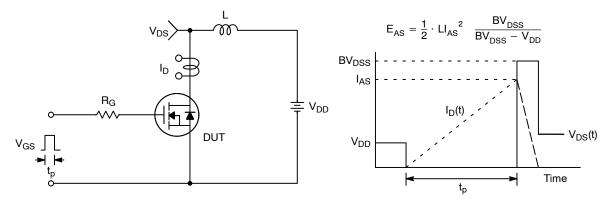


Figure 18. Unclamped Inductive Switching Test Circuit & Waveforms

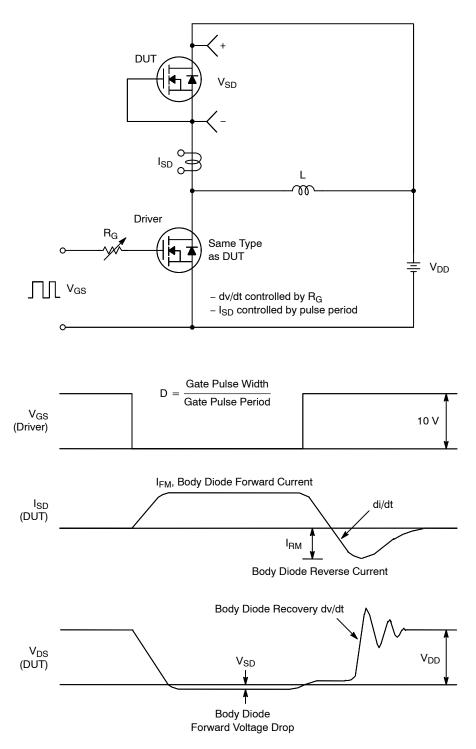


Figure 19. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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